

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type(π-MOSVI)

SSM5P16FU

High Speed Switching Applications

Analog Switch Applications

- Small package
- Low on-resistance : $R_{DS(ON)} = 8 \Omega$ (max) (@ $V_{GS} = -4 V$)
 : $R_{DS(ON)} = 12 \Omega$ (max) (@ $V_{GS} = -2.5 V$)
 : $R_{DS(ON)} = 45 \Omega$ (max) (@ $V_{GS} = -1.5 V$)

Absolute Maximum Ratings (Ta = 25°C) (Q1, Q2 Common)

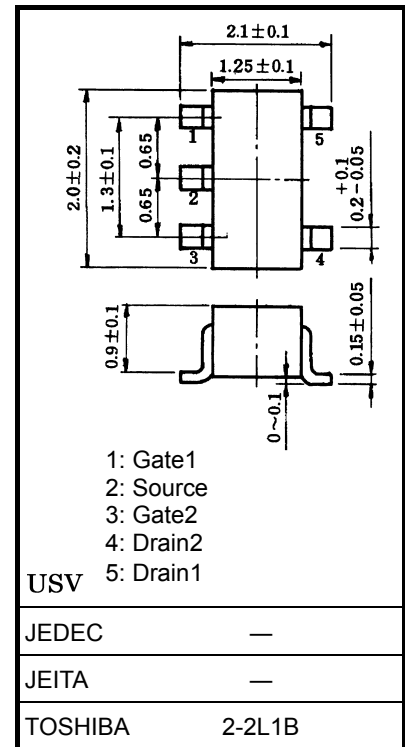
| Characteristics | | Symbol | Rating | Unit |
|---------------------------|-------|---------------|---------|------|
| Drain-Source voltage | | V_{DS} | -20 | V |
| Gate-Source voltage | | V_{GSS} | ±10 | V |
| Drain current | DC | I_D | -100 | mA |
| | Pulse | I_{DP} | -200 | |
| Power dissipation | | P_D (Note1) | 200 | mW |
| Channel temperature | | T_{ch} | 150 | °C |
| Storage temperature range | | T_{stg} | -55~150 | °C |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

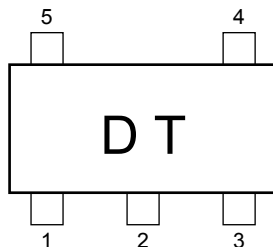
Note1: Total rating

Unit: mm

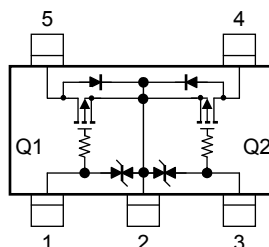


Weight: 6.2 mg (typ.)

Marking



Equivalent Circuit (top view)



Handling Precaution

When handling individual devices (which are not yet mounted on a circuit board), ensure that the environment is protected against static electricity. Operators should wear anti-static clothing, and containers and other objects that come into direct contact with devices should be made of anti-static materials.

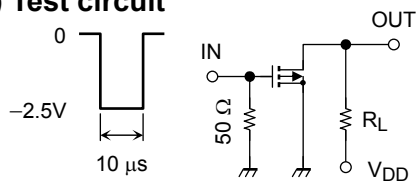
Electrical Characteristics (Ta = 25°C) (Q1, Q2 common)

| Characteristic | Symbol | Test Condition | MIN. | TYP. | MAX. | UNIT | |
|--------------------------------|---------------|---|---|------|---------|---------------|----|
| Gate leakage current | I_{GSS} | $V_{GS} = \pm 10\text{ V}, V_{DS} = 0$ | — | — | ± 1 | μA | |
| Drain-Source breakdown voltage | $V_{(BR)DSS}$ | $I_D = -0.1\text{ mA}, V_{GS} = 0$ | -20 | — | — | V | |
| Drain cut-off current | I_{DSS} | $V_{DS} = -20\text{ V}, V_{GS} = 0$ | — | — | -1 | μA | |
| Gate threshold voltage | V_{th} | $V_{DS} = -3\text{ V}, I_D = -0.1\text{ mA}$ | -0.6 | — | -1.1 | V | |
| Forward transfer admittance | $ Y_{fs} $ | $V_{DS} = -3\text{ V}, I_D = -10\text{ mA}$ (Note2) | 25 | — | — | mS | |
| Drain-Source on-resistance | $R_{DS(ON)}$ | $I_D = -10\text{ mA}, V_{GS} = -4\text{ V}$ (Note2) | — | 6 | 8 | Ω | |
| | | $I_D = -10\text{ mA}, V_{GS} = -2.5\text{ V}$ (Note2) | — | 8 | 12 | | |
| | | $I_D = -1\text{ mA}, V_{GS} = -1.5\text{ V}$ (Note2) | — | 18 | 45 | | |
| Input capacitance | C_{iss} | $V_{DS} = -3\text{ V}, V_{GS} = 0, f = 1\text{ MHz}$ | — | 11 | — | pF | |
| Reverse transfer capacitance | C_{rss} | | — | 3.7 | — | pF | |
| Output capacitance | C_{oss} | | — | 10 | — | pF | |
| Switching time | Turn-on time | t_{on} | $V_{DD} = -3\text{ V}, I_D = -10\text{ mA},$ $V_{GS} = 0 \sim -2.5\text{ V}$ | — | 130 | — | ns |
| | Turn-off time | t_{off} | | — | 190 | — | |

Note2: Pulse test

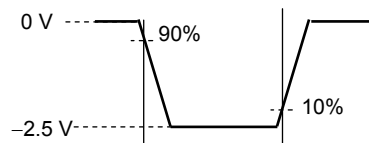
Switching Time Test Circuit

(a) Test circuit

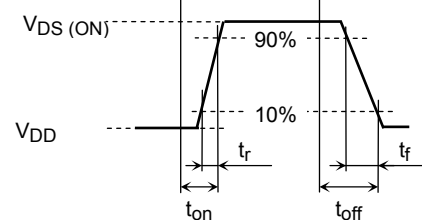


$V_{DD} = -3\text{ V}$
 Duty $\leq 1\%$
 V_{IN} : $t_r, t_f < 5\text{ ns}$
 ($Z_{out} = 50\ \Omega$)
 Common Source
 $T_a = 25^\circ\text{C}$

(b) V_{IN}



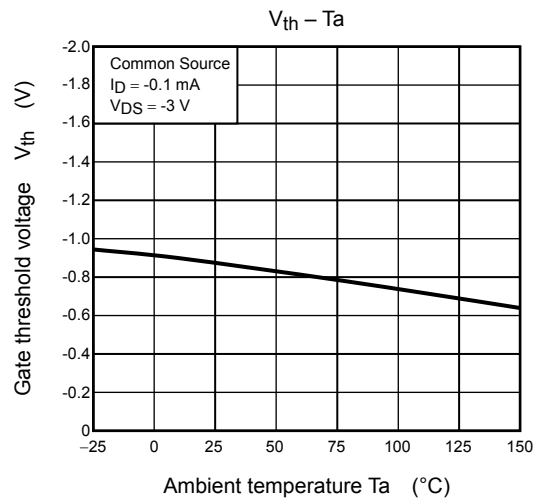
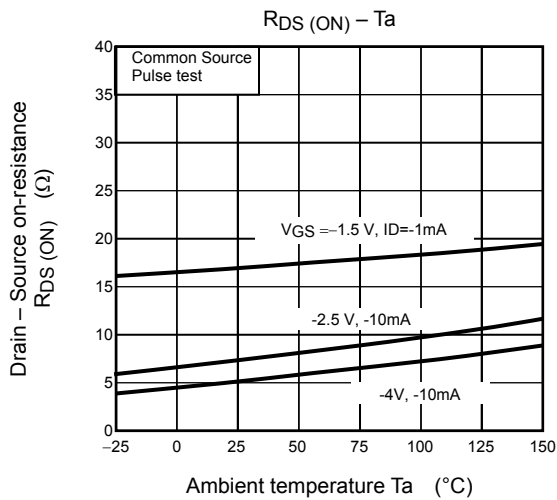
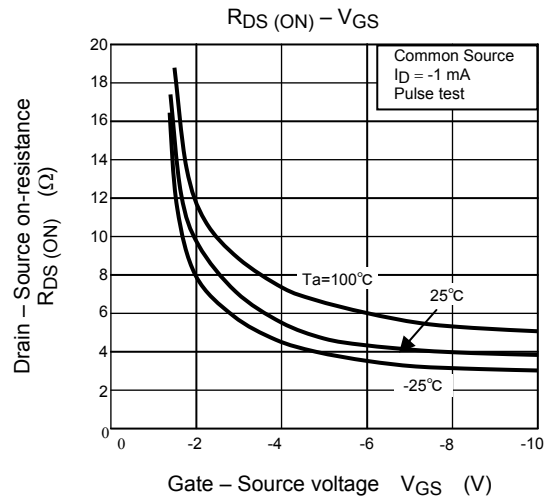
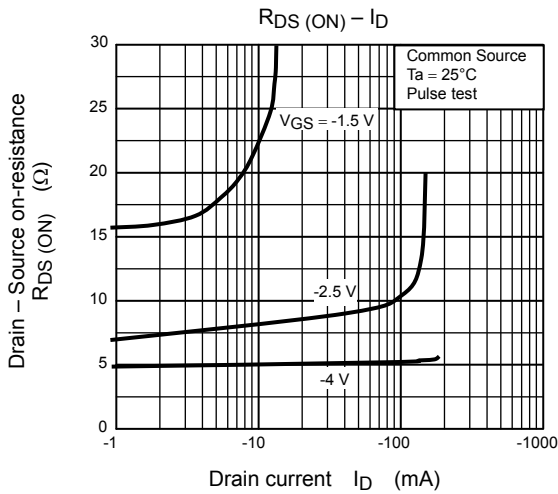
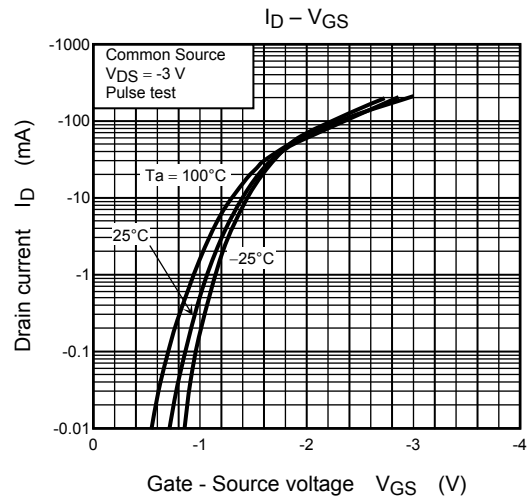
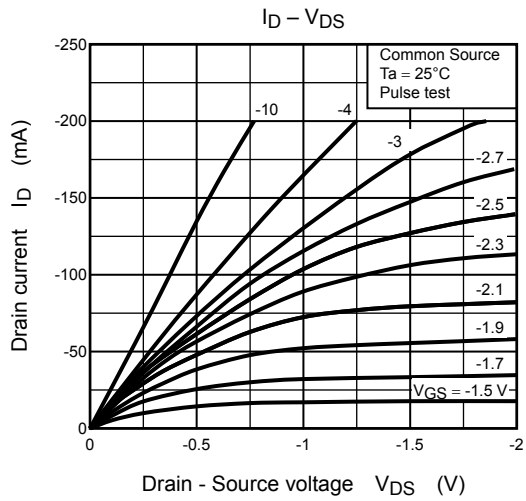
(c) V_{OUT}

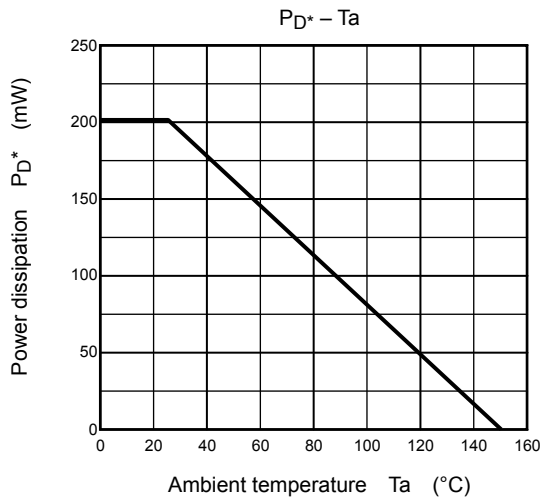
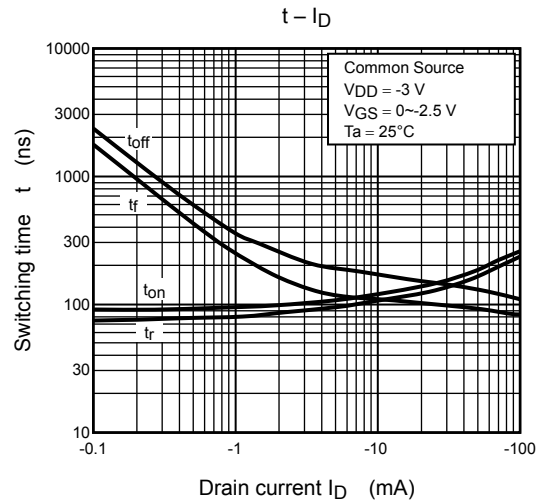
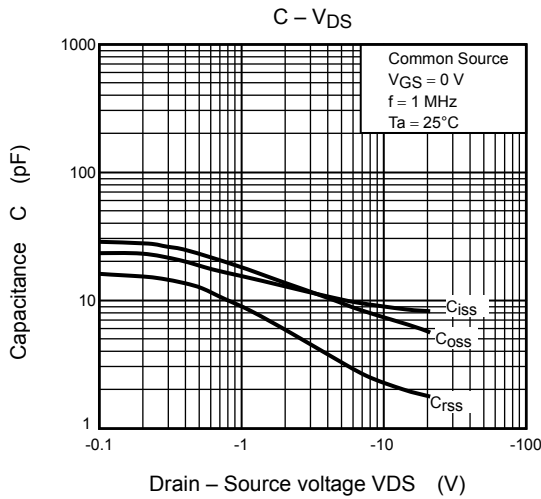
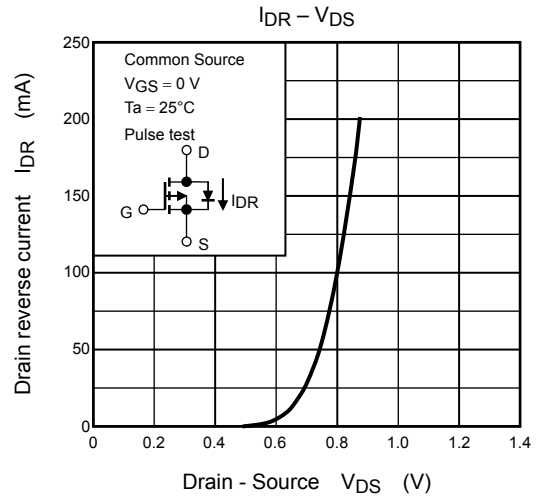
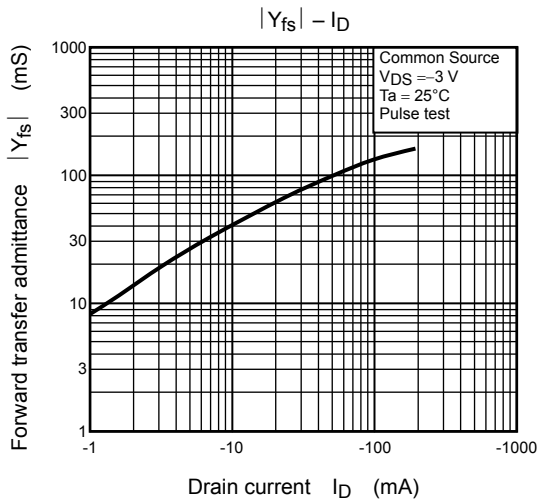


Precaution

V_{th} can be expressed as the voltage between the gate and source when the low operating current value is $I_D = -0.1\text{ mA}$ for this product. For normal switching operation, $V_{GS(ON)}$ requires a higher voltage than V_{th} and $V_{GS(OFF)}$ requires a lower voltage than V_{th} . (The relationship can be established as follows: $V_{GS(OFF)} < V_{th} < V_{GS(ON)}$.)

Be sure to take this into consideration when using the device.





*:Total rating

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